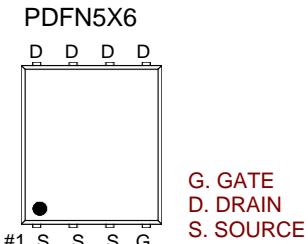


P -Channel High Density Trench MOSFET

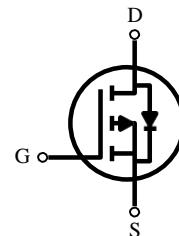
Features:

- Super high dense cell trench design for low RDS(on).
- Rugged and reliable.
- Surface Mount package.



PRODUCT SUMMARY

V _{(BR)DSS}	I _D
-30V	-60A
	-46A



ABSOLUTE MAXIMUM RATINGS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	-30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	-60	A
		-46	
Pulsed Drain Current (Note 1)	I _{DM}	-200	
Avalanche Current	I _{AS}	-18	
Single Pulse Avalanche Energy	E _{AS}	62	mJ
Maximum Power Dissipation (Note 1)	P _D	52	W
		21	
Operating Junction and Storage Temperature Range	T _J , T _{STG}	- 55 to 150	°C

TYPICAL THERMAL CHARACTERISTICS (Note 1)

Thermal Resistance,Junction-to-Case	R _{thJC}	2.5	°C/W
Thermal Resistance Junction-Ambient	R _{thJA}	62.5	°C/W

Note :

1. Pulse width limited by maximum junction temperature.



ELECTRICAL CHARACTERISTICS (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V , I _D = -250uA	-30			V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -24V , V _{GS} = 0V , T _j = 25°C			-1	uA
		V _{DS} = -24V , V _{GS} = 0V , T _j = 125°C			-30	
Gate-Body Leakage	I _{GSS}	V _{GS} = ±20V , V _{DS} = 0V			±100	nA
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = 250uA	-1	-1.6	-3	V
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = -10V , I _D = -20A		6.7	9	mΩ
		V _{GS} = -4.5V , I _D = -15A		10.8	12.8	mΩ
Forward Transconductance	g _{fs}	V _{DS} = -10V , I _D = -12A		23		S
DYNAMIC CHARACTERISTICS						
Input Capacitance	C _{ISS}	V _{DS} = -15V , V _{GS} = 0V f = 1.0MHz		3983		pF
Output Capacitance	C _{OSS}			348		pF
Reverse Transfer Capacitance	C _{RSS}			321		pF
Gate Resistance	R _g	V _{DS} = 0V , V _{GS} = 0V , f = 1.0MHz		9		Ω
SWITCHING CHARACTERISTICS (Note 3)						
Turn-On Delay Time	t _{d(ON)}	V _{DD} = -15V , I _D = -6A , V _{GS} = -10V R _{GS} = 6 Ω		32		nS
Rise Time	t _r			26		nS
Turn-Off Delay Time	t _{d(OFF)}			87		nS
Fall Time	t _f			45		nS
Total Gate Charge (10V)	Q _g	V _{DS} = -15BV _{DSS} , I _D = -20A V _{GS} = -10V		72.8		nC
Total Gate Charge (4.5V)	Q _g			58.7		nC
Gate-Source Charge	Q _{gs}			17.5		nC
Gate-Drain Charge	Q _{gd}			16.6		nC
DRAIN-SOURCE DIODE CHARACTERISTICS						
Continuous Current	I _S				-18	A
Diode Forward Voltage (Note 2)	V _{SD}	V _{GS} = 0V , I _S = I _F		-0.75	-1.25	V

Note :

2. Pulse Test Pulse width ≤ 300usec , Duty Cycle ≤ 2%

3. Independent of operating production testing .

